

Features

- 650 Volt Schottky Rectifier
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F

Benefits

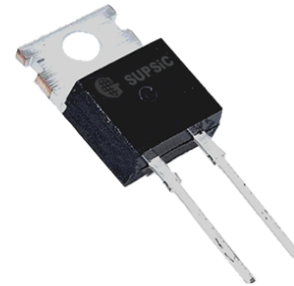
- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Applications

- Switch Mode Power Supplies (SMPS)
- Boost diodes in PFC or DC/DC stages
- Free Wheeling Diodes in Inverter stages
- AC/DC converters

| Part Number | Package | Marking |
|-------------|----------|-----------|
| GC3D16065A | TO-220-2 | GC3D16065 |

| | | |
|-------------------------------|---|---------|
| V_{RRM} | = | 650 V |
| $I_F (T_C=135^\circ\text{C})$ | = | 18 A |
| Q_c | = | 44.5 nC |



TO-220-2

Package



Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Value | | Test Conditions | Note |
|----------------|--|----------------|------------------|---|--------|
| V_{RRM} | Repetitive Peak Reverse Voltage | 650 | V | | |
| V_{RSM} | Surge Peak Reverse Voltage | 650 | V | | |
| V_{DC} | DC Blocking Voltage | 650 | V | | |
| I_F | Continuous Forward Current | 39 18 16 | A | $T_C=25^\circ\text{C}$ $T_C=135^\circ\text{C}$ $T_C=142^\circ\text{C}$ | Fig. 3 |
| I_{FRM} | Repetitive Peak Forward Surge Current | 66 46 | A | $T_C=25^\circ\text{C}$, $t_p=10$ ms, Half Sine Pulse $T_C=110^\circ\text{C}$, $t_p=10$ ms, Half Sine Pulse | |
| I_{FSM} | Non-Repetitive Peak Forward Surge Current | 162 150 | A | $T_C=25^\circ\text{C}$, $t_p=10$ ms, Half Sine Pulse $T_C=110^\circ\text{C}$, $t_p=10$ ms, Half Sine Pulse | Fig. 8 |
| I_{FMax} | Non-Repetitive Peak Forward Current | 1400 1200 | A | $T_C=25^\circ\text{C}$, $t_p=10$ μs , Pulse $T_C=110^\circ\text{C}$, $t_p=10$ μs , Pulse | Fig. 8 |
| P_{tot} | Power Dissipation | 150 65 | W | $T_C=25^\circ\text{C}$ $T_C=110^\circ\text{C}$ | Fig. 4 |
| dV/dt | Diode dV/dt ruggedness | 200 | V/ns | $V_R=0-600\text{V}$ | |
| $\int i^2 dt$ | i^2t value | 131 112.5 | A ² s | $T_C=25^\circ\text{C}$, $t_p=10$ ms $T_C=110^\circ\text{C}$, $t_p=10$ ms | |
| T_J, T_{stg} | Operating Junction and Storage Temperature | -55 to +175 | $^\circ\text{C}$ | | |
| | TO-220 Mounting Torque | 1 8.8 | Nm lbf-in | M3 Screw 6-32 Screw | |

Electrical Characteristics

| Symbol | Parameter | Typ. | Max. | Unit | Test Conditions | Note |
|--------|---------------------------|-------------------|------------|---------------|--|--------|
| V_F | Forward Voltage | 1.5 2.0 | 1.8 2.4 | V | $I_F = 16\text{ A}$ $T_J = 25^\circ\text{C}$ $I_F = 16\text{ A}$ $T_J = 175^\circ\text{C}$ | Fig. 1 |
| I_R | Reverse Current | 18.5 38.5 | 95 378 | μA | $V_R = 650\text{ V}$ $T_J = 25^\circ\text{C}$ $V_R = 650\text{ V}$ $T_J = 175^\circ\text{C}$ | Fig. 2 |
| Q_C | Total Capacitive Charge | 44.5 | | nC | $V_R = 400\text{ V}$, $I_F = 16\text{ A}$ $di/dt = 500\text{ A}/\mu\text{s}$ $T_J = 25^\circ\text{C}$ | Fig. 5 |
| C | Total Capacitance | 877.5 80 64 | | pF | $V_R = 0\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 200\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 400\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ | Fig. 6 |
| E_C | Capacitance Stored Energy | 6.2 | | μJ | $V_R = 400\text{ V}$ | Fig. 7 |

Note: This is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

| Symbol | Parameter | Typ. | Unit | Note |
|-----------------|--|------|---------------------------|--------|
| $R_{\theta JC}$ | Thermal Resistance from Junction to Case | 1 | $^\circ\text{C}/\text{W}$ | Fig. 9 |

Typical Performance

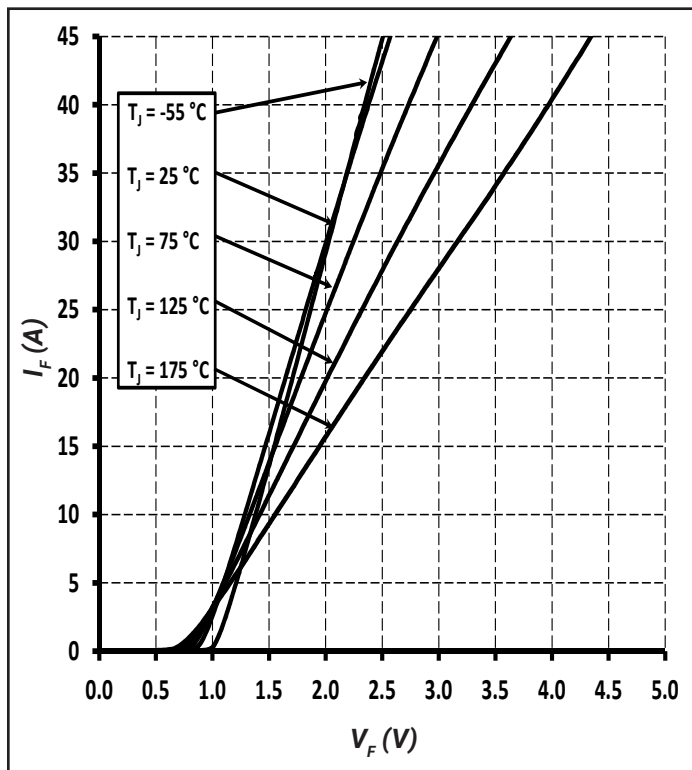


Figure 1. Forward Characteristics

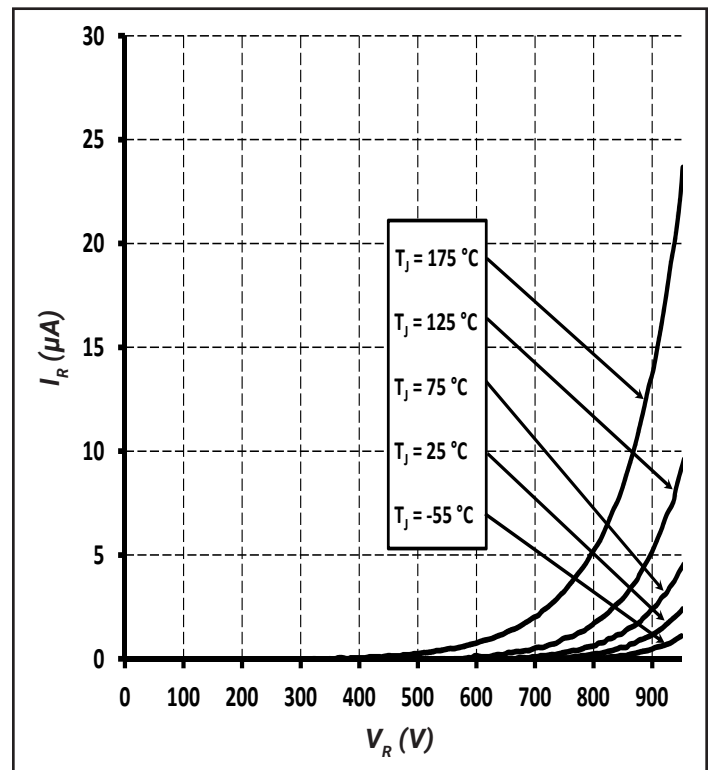


Figure 2. Reverse Characteristics

Typical Performance

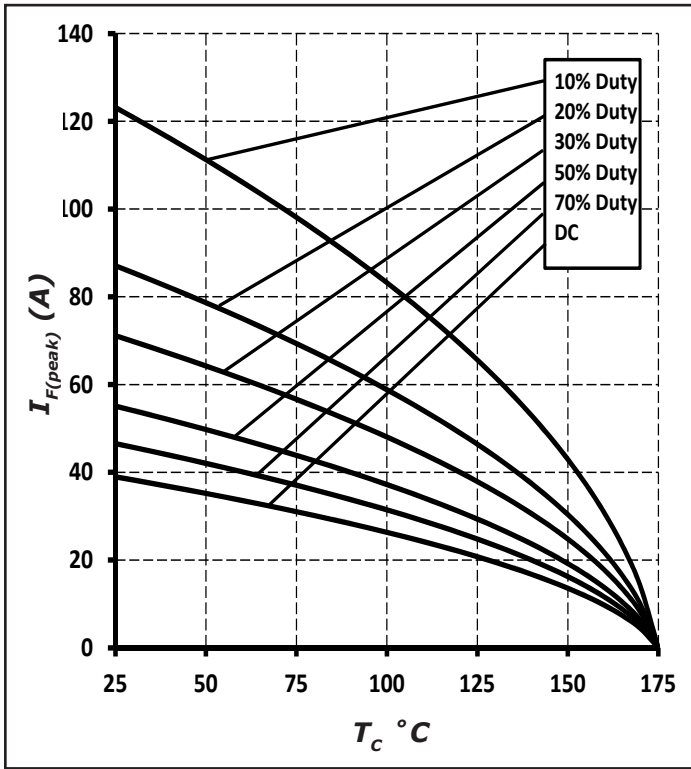


Figure 3. Current Derating

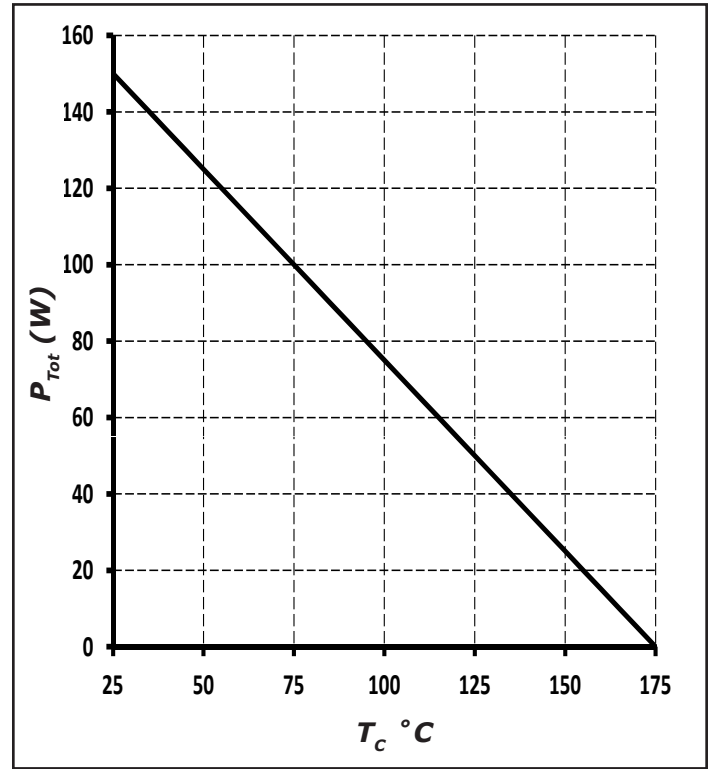


Figure 4. Power Derating

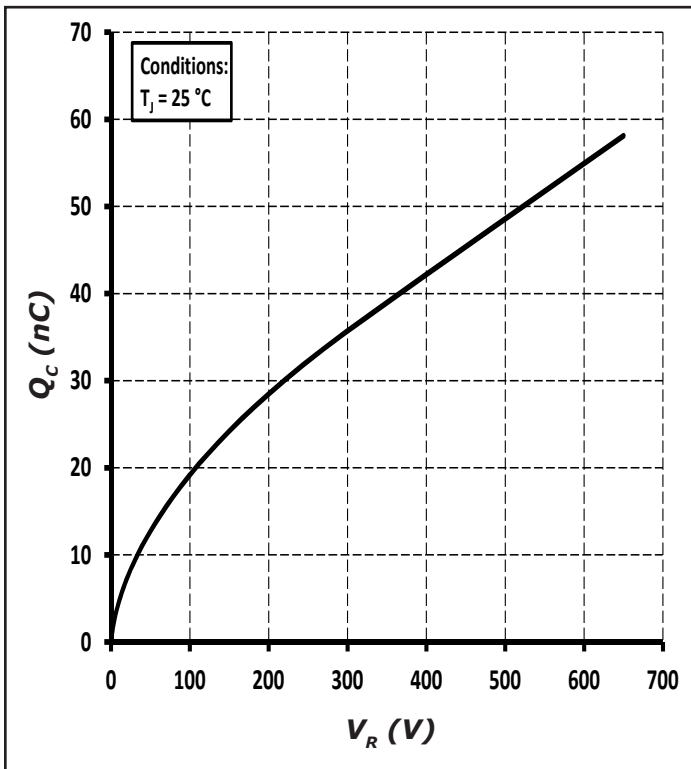


Figure 5. Total Capacitance Charge vs. Reverse Voltage

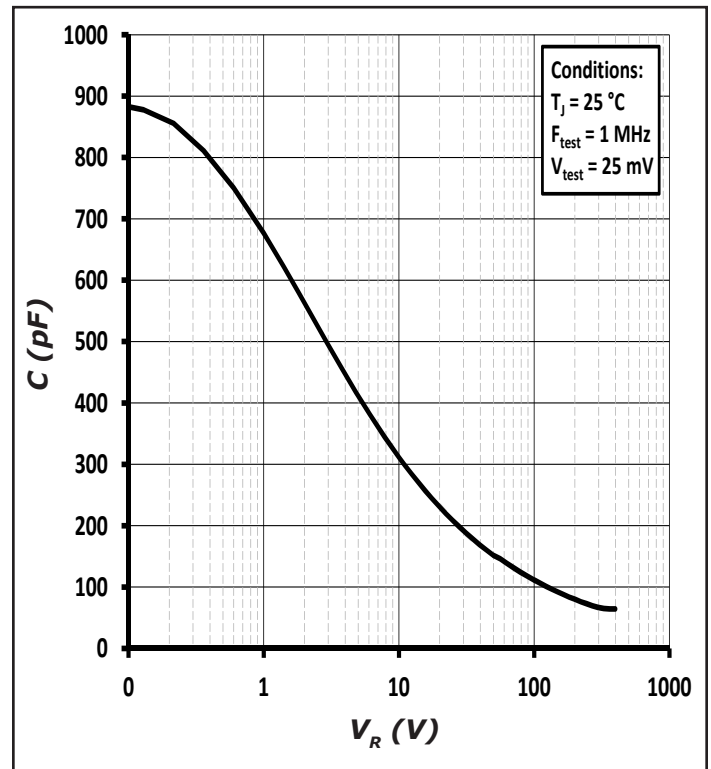


Figure 6. Capacitance vs. Reverse Voltage

Typical Performance

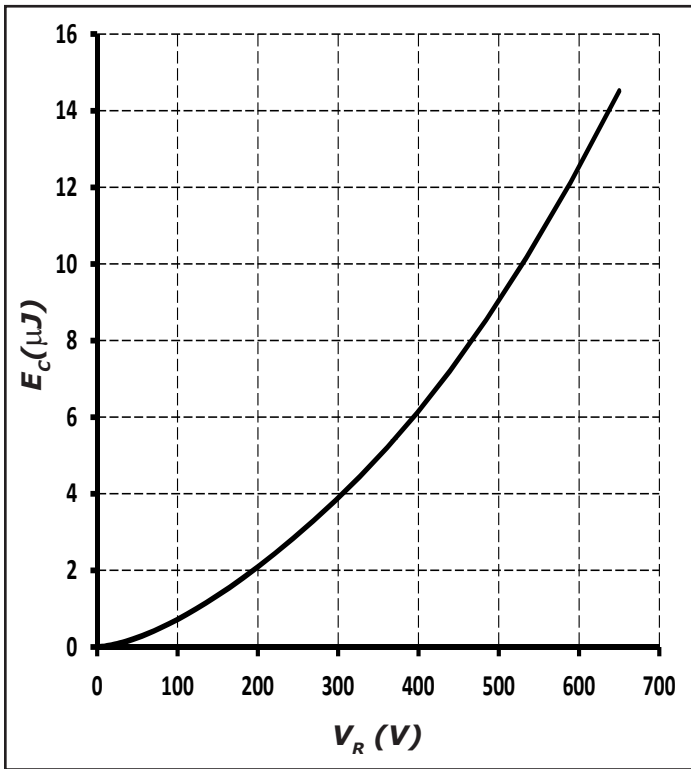


Figure 7. Capacitance Stored Energy

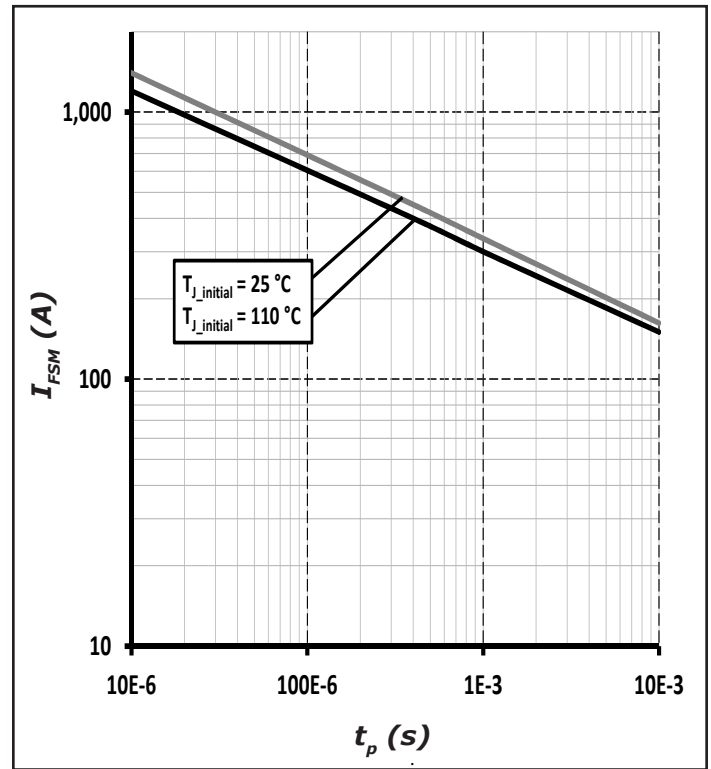


Figure 8. Non-repetitive peak forward surge current versus pulse duration (sinusoidal waveform)

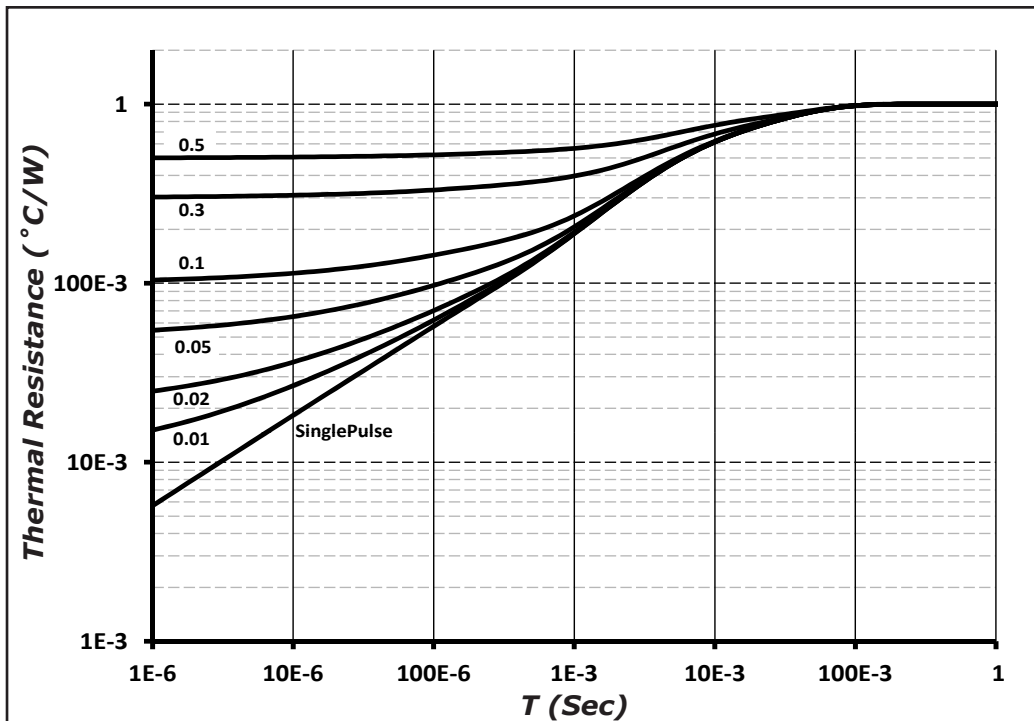
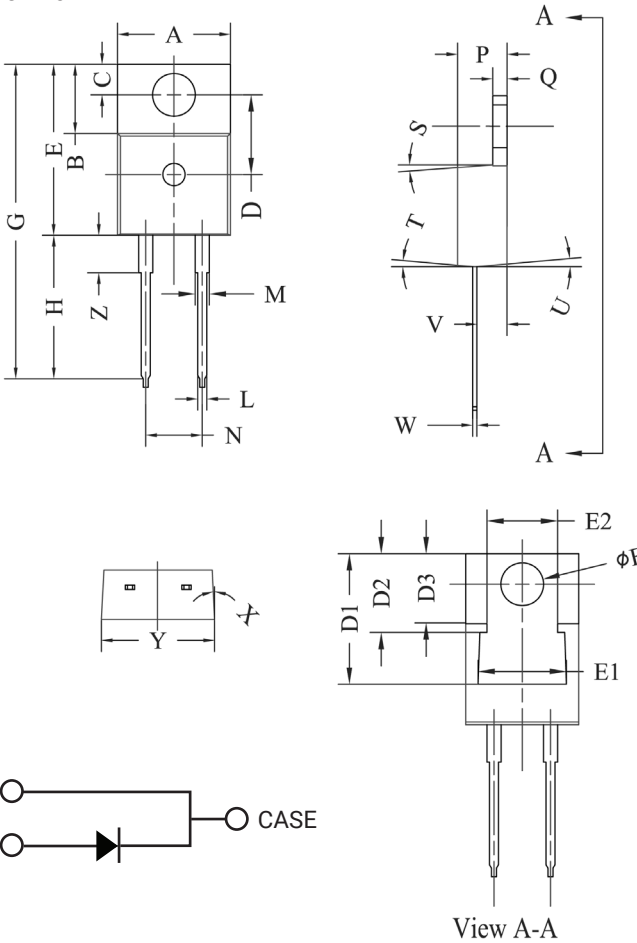


Figure 9. Transient Thermal Impedance

Package Dimensions

Package TO-220-2

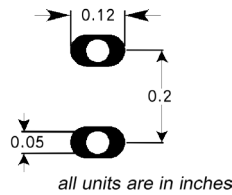


| POS | Inches | | Millimeters | |
|-----|---------------|-------|-----------------|--------|
| | Min | Max | Min | Max |
| A | .381 | .410 | 9.677 | 10.414 |
| B | .235 | .255 | 5.969 | 6.477 |
| C | .100 | .120 | 2.540 | 3.048 |
| D | .223 | .337 | 5.664 | 8.560 |
| D1 | .457-.490 | | 11.60-12.45 typ | |
| D2 | .277-.303 typ | | 7.04-7.70 typ | |
| D3 | .244-.252 typ | | 6.22-6.4 typ | |
| E | .590 | .615 | 14.986 | 15.621 |
| E1 | .302 | .326 | 7.68 | 8.28 |
| E2 | .227 | .251 | 5.77 | 6.37 |
| F | .143 | .153 | 3.632 | 3.886 |
| G | 1.105 | 1.147 | 28.067 | 29.134 |
| H | .500 | .550 | 12.700 | 13.970 |
| L | .025 | .036 | .635 | .914 |
| M | .045 | .055 | 1.143 | 1.550 |
| N | .195 | .205 | 4.953 | 5.207 |
| P | .165 | .185 | 4.191 | 4.699 |
| Q | .048 | .054 | 1.219 | 1.372 |
| S | 3° | 6° | 3° | 6° |
| T | 3° | 6° | 3° | 6° |
| U | 3° | 6° | 3° | 6° |
| V | .094 | .110 | 2.388 | 2.794 |
| W | .014 | .025 | .356 | .635 |
| X | 3° | 5.5° | 3° | 5.5° |
| Y | .385 | .410 | 9.779 | 10.414 |
| Z | .130 | .150 | 3.302 | 3.810 |

NOTE:

1. Dimension L, M, W apply for Solder Dip Finish

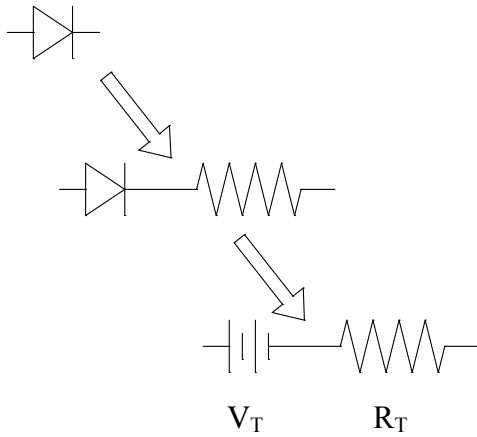
Recommended Solder Pad Layout



TO-220-2

| Part Number | Package |
|-------------|----------|
| GC3D16065A | TO-220-2 |

Diode Model



$$V_{fT} = V_T + I_f * R_T$$

$$V_T = 0.94 + (T_J * -1.0 * 10^{-3})$$

$$R_T = 0.027 + (T_J * 2.8 * 10^{-4})$$

Note: T_J = Diode Junction Temperature In Degrees Celsius,
valid from 25°C to 175°C